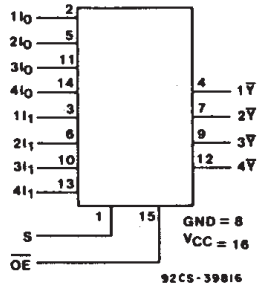


CD54/74HC258 CD54/74HCT258



Data sheet acquired from Harris Semiconductor
SCHS276

High-Speed CMOS Logic



FUNCTIONAL DIAGRAM

Quad 2-Input Multiplexer with 3-State Inverting Outputs

Type Features:

- Buffered inputs
- Typical CD54/74HC258 propagation delay = 7 ns @ $V_{CC} = 5\text{ V}$, $C_L = 15\text{ pF}$, $T_A = 25^\circ\text{C}$

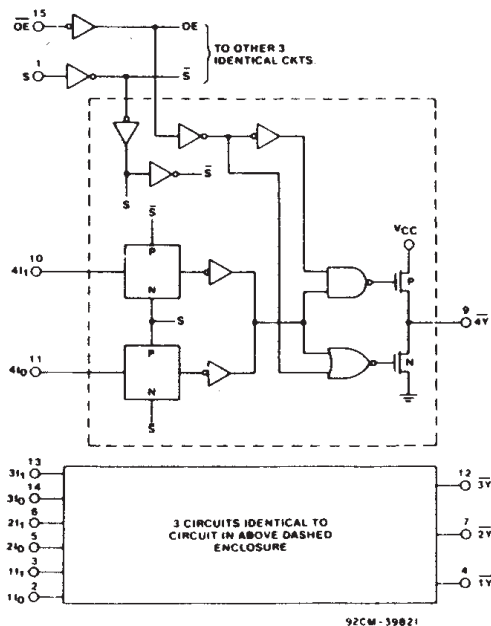
The RCA-CD54/74HC258 and CD54/74HCT258 are quad 2-input multiplexers which select four bits of data from two sources under the control of a common Select input (S). The Output Enable input (\overline{OE}) is active LOW. When \overline{OE} is HIGH, all of the outputs (1Y-4Y) are in the high impedance state regardless of all other input conditions.

Moving data from two groups of registers to four common output busses is a common use of the 258. The state of the Select input determines the particular register from which the data comes. It can also be used as a function generator.

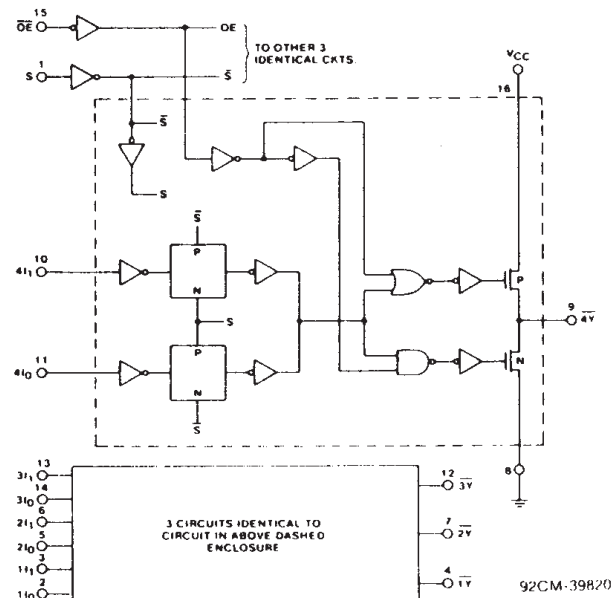
The CD54HC/HCT258 are supplied in 16-lead hermetic dual-in-line ceramic packages (F suffix). The CD74HC/HCT258 are supplied in 16-lead dual-in-line plastic packages (E suffix) and in 16-lead dual-in-line surface mount plastic packages (M suffix). Both types are also available in chip form (H suffix).

Family Features:

- Fanout (Over Temperature Range):
Standard Outputs - 10 LSTTL Loads
Bus Driver Outputs - 15 LSTTL Loads
- Wide Operating Temperature Range:
CD74HC/HCT/HCU: -40 to $+85^\circ\text{C}$
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- Alternate Source is Philips/Signetics
- CD54HC/CD74HC Types:
2 to 6 V Operation
High Noise Immunity:
 $N_{IL} = 30\%$, $N_{IH} = 30\%$ of V_{CC} ; @ $V_{CC} = 5\text{ V}$
- CD54HCT/CD74HCT Types:
4.5 to 5.5 V Operation
Direct LSTTL Input Logic Compatibility
 $V_{IL} = 0.8\text{ V Max.}$, $V_{IH} = 2\text{ V Min.}$
CMOS Input Compatibility
 $I_1 \leq 1\text{ }\mu\text{A}$ @ V_{OL} , V_{OH}



CD54/74HC258 Logic Diagram



CD54/74HCT258 Logic Diagram

CD54/74HC258 CD54/74HCT258

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE, (V_{CC}):
(Voltages referenced to ground) -0.5 to + 7 V

DC INPUT DIODE CURRENT, I_{IK} (FOR $V_i < -0.5$ V OR $V_i > V_{CC} + 0.5$ V) ± 20 mA

DC OUTPUT DIODE CURRENT, I_{OK} (FOR $V_o < -0.5$ V OR $V_o > V_{CC} + 0.5$ V) ± 20 mA

DC DRAIN CURRENT, PER OUTPUT (I_o) (FOR -0.5 V $< V_o < V_{CC} + 0.5$ V) ± 35 mA

DC V_{CC} OR GROUND CURRENT (I_{CC}) ± 70 mA

POWER DISSIPATION PER PACKAGE (P_D):
For $T_A = -40$ to $+60^\circ$ C (PACKAGE TYPE E) 500 mW
For $T_A = +60$ to $+85^\circ$ C (PACKAGE TYPE E) Derate Linearly at 8 mW/ $^\circ$ C to 300 mW
For $T_A = -55$ to $+100^\circ$ C (PACKAGE TYPE F, H) 500 mW
For $T_A = +100$ to $+125^\circ$ C (PACKAGE TYPE F, H) Derate Linearly at 8 mW/ $^\circ$ C to 300 mW
For $T_A = -40$ to $+70^\circ$ C (PACKAGE TYPE M) 400 mW
For $T_A = +70$ to $+125^\circ$ C (PACKAGE TYPE M) Derate Linearly at 6 mW/ $^\circ$ C to 70 mW

OPERATING-TEMPERATURE RANGE (T_A):
PACKAGE TYPE F, H -55 to $+125^\circ$ C
PACKAGE TYPE E, M -40 to $+85^\circ$ C

STORAGE TEMPERATURE (T_{STG}) -65 to $+150^\circ$ C

LEAD TEMPERATURE (DURING SOLDERING):
At distance $1/16 \pm 1/32$ in. (1.59 ± 0.79 mm) from case for 10 s max. $+265^\circ$ C
Unit inserted into a PC Board (min. thickness $1/16$ in., 1.59 mm)
with solder contacting lead tips only $+300^\circ$ C

RECOMMENDED OPERATING CONDITIONS:

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

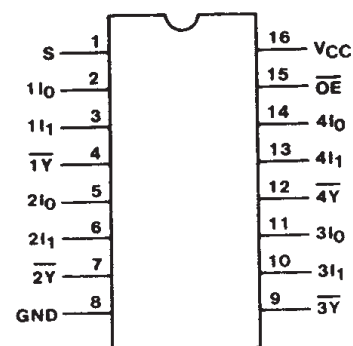
CHARACTERISTIC	LIMITS		UNITS
	MIN.	MAX.	
Supply-Voltage Range (For $T_A =$ Full Package-Temperature Range) V_{CC} .* CD54/74HC Types CD54/74HCT Types	2 4.5	6 5.5	V
DC Input or Output Voltage V_i, V_o	0	V_{CC}	V
Operating Temperature T_A : CD74 Types CD54 Types	-40 -55	+85 +125	$^\circ$ C
Input Rise and Fall Times t_r, t_f at 2 V at 4.5 V at 6 V	0 0 0	1000 500 400	ns

*Unless otherwise specified, all voltages are referenced to Ground.

FUNCTION TABLE

Output Enable	Select Input	Data Inputs		Output
		I_0	I_1	
\overline{OE}	S	I_0	I_1	\overline{Y}
H	X	X	X	Z
L	L	L	X	H
L	L	H	X	L
L	H	X	L	H
L	H	X	H	L

H = High level voltage
L = Low level voltage
X = Don't care.
Z = High impedance (off) state



92CS-39015

TERMINAL ASSIGNMENT

CD54/74HC258 CD54/74HCT258

STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CD74HC258/CD54HC258										CD74HCT258/CD54HCT258								UNITS			
	TEST CONDITIONS			74HC/54HC TYPES			74HC TYPE		54HC TYPE			TEST CONDITIONS		74HCT/54HCT TYPES			74HCT TYPE			54HCT TYPE		
	V _I V	I _O mA	V _{CC} V	+25°C			-40/ +85°C		-55/ +125°C			V _I V	V _{CC} V	+25°C			-40/ +85°C			-55/ +125°C		
				Min	Typ	Max	Min	Max	Min	Max	Min			Max	Min	Max	Min	Max				
High-Level Input Voltage V _{IH}			2	1.5	—	—	1.5	—	1.5	—	—	4.5		2	—	—	2	—	2	—	V	
			4.5	3.15	—	—	3.15	—	3.15	—	—	to										
			6	4.2	—	—	4.2	—	4.2	—	—	5.5										
Low-Level Input Voltage V _{IL}			2	—	—	0.5	—	0.5	—	0.5	—	4.5									V	
			4.5	—	—	1.35	—	1.35	—	1.35	—	to			0.8	—	0.8	—	0.8	—		
			6	—	—	1.8	—	1.8	—	1.8	—	5.5										
High-Level Output Voltage V _{OH}	V _{IL} or V _{IH}	-0.02	2	1.9	—	—	1.9	—	1.9	—	V _{IL} or V _{IH}	4.5	4.4	—	—	4.4	—	4.4	—	4.4	—	V
CMOS Loads			4.5	4.4	—	—	4.4	—	4.4	—												
			6	5.9	—	—	5.9	—	5.9	—												
TTL Loads (Bus Driver)	V _{IL} or V _{IH}	-6 -7.8	4.5	3.98	—	—	3.84	—	3.7	—	V _{IL} or V _{IH}	4.5	3.98	—	—	3.84	—	3.7	—		V	
Low-Level Output Voltage V _{OL}	V _{IL} or V _{IH}	0.02	2	—	—	0.1	—	0.1	—	0.1	V _{IL} or V _{IH}	4.5	—	—	0.1	—	0.1	—	0.1	—	0.1	V
CMOS Loads			4.5	—	—	0.1	—	0.1	—	0.1												
			6	—	—	0.1	—	0.1	—	0.1												
TTL Loads (Bus Driver)	V _{IL} or V _{IH}	6 7.8	4.5	—	—	0.26	—	0.33	—	0.4	V _{IL} or V _{IH}	4.5	—	—	0.26	—	0.33	—	0.4	—		V
Input Leakage Current I _I	V _{CC} or Gnd		6	—	—	±0.1	—	±1	—	±1	Any Voltage Between V _{CC} & Grid	5.5	—	—	±0.1	—	±1	—	±1	—	±1	μA
Quiescent Device Current I _{CC}	V _{CC} or Gnd	0	6	—	—	8	—	80	—	160	V _{CC} or Gnd	5.5	—	—	8	—	80	—	160	—	160	μA
Additional Quiescent Device Current per input pin: 1 unit load ΔI _{CC} *											V _{CC} -2.1	4.5 to 5.5	—	100	360	—	450	—	490	—	490	μA
3-State leakage current I _{OZ}	V _{IL} or V _{IH}	V _O = V _{CC} or Gnd	6	—	—	±0.5	—	±5	—	±10	V _{IL} or V _{IH}	5.5	—	—	±0.5	—	±5	—	±10	—	±10	μA

*For dual-supply systems theoretical worst case (V_I = 2.4 V, V_{CC} = 5.5 V) specification is 1.8 mA.

HCT Input Loading Table

Input	Unit Loads*
Data	0.5
S	1.5
OE	1.5

*Unit Load is ΔI_{CC} limit specified in Static Characteristic Chart, e.g., 360 μA max. @ 25°C.

CD54/74HC258 CD54/74HCT258

SWITCHING CHARACTERISTICS (V_{CC} = 5 V, T_A = 25°C, Input t_r, t_f = 6 ns)

CHARACTERISTIC	CL (pF)	TYPICAL		UNITS
		HC	HCT	
nI _O , nI _I , to \bar{Y} , t_{PHL} t_{PLH}	15	7	11	ns
\bar{OE} to \bar{Y}	t_{PZL} t_{PZH}	15	11	ns
	t_{PLZ} t_{PHZ}	15	12	ns
S to \bar{Y}	t_{PHL} t_{PLH}	15	14	ns
Power Dissipation Capacitance*	C _{PD}	—	49	pF

*C_{PD} is used to determine the dynamic power consumption, per multiplexer.
 $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$ where: f_i = input frequency
 C_L = output load capacitance
 V_{CC} = supply voltage

SWITCHING CHARACTERISTICS (C_L = 50 pF, Input t_r, t_f = 6 ns)

CHARACTERISTIC	V _{CC}	25°C				-40°C to +85°C				-55°C to +125°C				UNITS	
		HC		HCT		74HC		74HCT		54HC		54HCT			
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.		
Propagation Delay, nI _O , nI _I , to \bar{Y} (Fig. 2)	t_{PLH}	2	—	95	—	—	—	120	—	—	—	145	—	—	ns
	t_{PHL}	4.5	—	19	—	27	—	24	—	34	—	29	—	41	
		6	—	15	—	—	—	20	—	—	—	25	—	—	
Propagation Delay S to \bar{Y} (Fig. 3)	t_{PLH}	2	—	140	—	—	—	175	—	—	—	210	—	—	ns
	t_{PHL}	4.5	—	28	—	34	—	35	—	43	—	42	—	51	
		6	—	24	—	—	—	30	—	—	—	36	—	—	
Propagation Delay \bar{OE} to Y (Fig. 4)	t_{PZL}	2	—	140	—	—	—	175	—	—	—	210	—	—	ns
	t_{PZH}	4.5	—	28	—	28	—	35	—	35	—	42	—	42	
		6	—	24	—	—	—	30	—	—	—	36	—	—	
Propagation Delay \bar{OE} to Y (Fig. 4)	t_{PLZ}	2	—	150	—	—	—	190	—	—	—	225	—	—	ns
	t_{PHZ}	4.5	—	30	—	30	—	38	—	38	—	45	—	45	
		6	—	26	—	—	—	33	—	—	—	38	—	—	
Output Transition Time (Fig. 2)	t_{TLH}	2	—	60	—	—	—	75	—	—	—	90	—	—	ns
	t_{THL}	4.5	—	12	—	12	—	15	—	15	—	18	—	18	
		6	—	10	—	—	—	13	—	—	—	15	—	—	
Input Capacitance	C _I		—	10	—	10	—	10	—	10	—	10	—	10	pF
3-State Output Capacitance	C _O		—	20	—	20	—	20	—	20	—	20	—	20	pF

CD54/74HC258 CD54/74HCT258

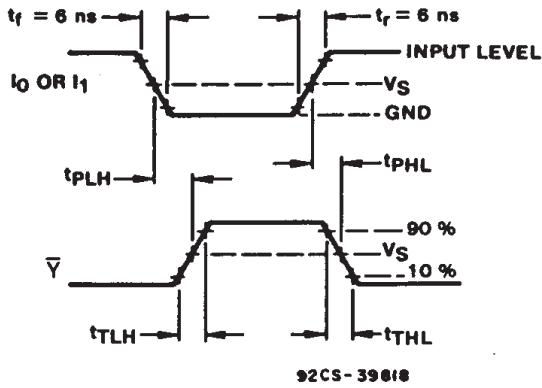


Fig. 2 - Select to output delays.

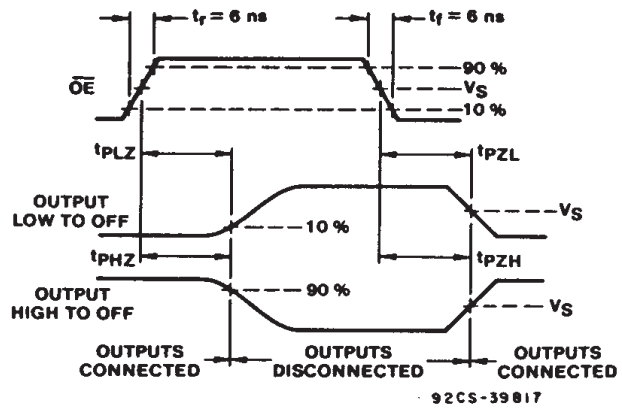


Fig. 4 - Output Enable to output propagation delays.

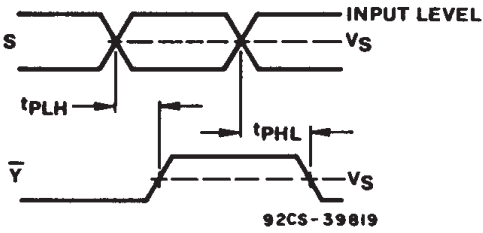


Fig. 3 - Select to output propagation delays.

	54/74HC	54/74HCT
Input Level	V_{CC}	3V
Switching Voltage, V_S	50% V_{CC}	1.3 V

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.